

United States Patent and Trademark Office

UNITED STATES DEPARTMENT OF COMMERCE United States Patent and Trademark Office Address: COMMISSIONER FOR PATENTS P.O. Box 1450 Alexandria, Virginia 22313-1450 www.uspto.gov

APPLICATION NO.	FILING DATE	FIRST NAMED INVENTOR	ATTORNEY DOCKET NO.	CONFIRMATION NO.
10/785,535	02/23/2004	Allen Cheah Chong Leng	080889-5045-US	1525
48591	48591 7590 09/25/2006		EXAMINER	
MORGAN, LEWIS & BOCKIUS LLP			OWENS, DOUGLAS W	
IIII PENNSYLVANIA AVENUE WASHINGTON, DC 20004			ART UNIT	PAPER NUMBER
	,		2811	

DATE MAILED: 09/25/2006

Please find below and/or attached an Office communication concerning this application or proceeding.

		Application No.	Applicant(s)			
Office Action Summary		10/785,535	LENG ET AL.			
		Examiner	Art Unit			
		Douglas W. Owens	2811			
The MAILING DATE of this communication appears on the cover sheet with the correspondence address Period for Reply						
WHIC - Exter after - If NO - Failu Any	ORTENED STATUTORY PERIOD FOR REPLY CHEVER IS LONGER, FROM THE MAILING DATE of the may be available under the provisions of 37 CFR 1.13 SIX (6) MONTHS from the mailing date of this communication. It period for reply is specified above, the maximum statutory period were to reply within the set or extended period for reply will, by statute, reply received by the Office later than three months after the mailing and patent term adjustment. See 37 CFR 1.704(b).	ATE OF THIS COMMUNICATION 36(a). In no event, however, may a reply be tim rill apply and will expire SIX (6) MONTHS from cause the application to become ABANDONE	N. sely filed the mailing date of this communication. D (35 U.S.C. § 133).			
Status						
•	Responsive to communication(s) filed on 28 Ju					
<i>,</i> —	This action is FINAL . 2b) ☐ This action is non-final.					
3)	Since this application is in condition for allowance except for formal matters, prosecution as to the merits is					
closed in accordance with the practice under Ex parte Quayle, 1935 C.D. 11, 453 O.G. 213.						
Dispositi	ion of Claims					
•	 4) Claim(s) 1-36 is/are pending in the application. 4a) Of the above claim(s) is/are withdrawn from consideration. 					
	5) Claim(s) 1-34 is/are allowed.					
·	Claim(s) <u>35-36</u> is/are rejected.					
,	Claim(s) is/are objected to.	. alaatian waxuinamaant	•			
8)[_]	Claim(s) are subject to restriction and/or	r election requirement.				
Applicati	ion Papers					
9)□	The specification is objected to by the Examine	r.				
10) ☐ The drawing(s) filed on is/are: a) ☐ accepted or b) ☐ objected to by the Examiner.						
Applicant may not request that any objection to the drawing(s) be held in abeyance. See 37 CFR 1.85(a).						
Replacement drawing sheet(s) including the correction is required if the drawing(s) is objected to. See 37 CFR 1.121(d). 11) The oath or declaration is objected to by the Examiner. Note the attached Office Action or form PTO-152.						
Priority (under 35 U.S.C. § 119					
12) Acknowledgment is made of a claim for foreign priority under 35 U.S.C. § 119(a)-(d) or (f). a) All b) Some * c) None of:						
1. Certified copies of the priority documents have been received.						
2. Certified copies of the priority documents have been received in Application No						
3. Copies of the certified copies of the priority documents have been received in this National Stage						
application from the International Bureau (PCT Rule 17.2(a)).						
* See the attached detailed Office action for a list of the certified copies not received.						
Attachmen	ut(e)	,				
_	ce of References Cited (PTO-892)	4) Interview Summary	(PTO-413)			
2) Notic	ce of Draftsperson's Patent Drawing Review (PTO-948)	Paper No(s)/Mail Do	ate			
	mation Disclosure Statement(s) (PTO/SB/08) er No(s)/Mail Date	6) Other:	atent Application			

Application/Control Number: 10/785,535 Page 2

Art Unit: 2811

DETAILED ACTION

Claim Objections

1. Claim 36 is objected to because of the following informalities: in line 3 of the claim "forgers" should be replaced with --fingers--. Appropriate correction is required.

Claim Rejections - 35 USC § 103

- 2. The following is a quotation of 35 U.S.C. 103(a) which forms the basis for all obviousness rejections set forth in this Office action:
 - (a) A patent may not be obtained though the invention is not identically disclosed or described as set forth in section 102 of this title, if the differences between the subject matter sought to be patented and the prior art are such that the subject matter as a whole would have been obvious at the time the invention was made to a person having ordinary skill in the art to which said subject matter pertains. Patentability shall not be negatived by the manner in which the invention was made.
- 3. Claims 35 and 36 are rejected under 35 U.S.C. 103(a) as being unpatentable over US Patent No. 6,538,313 to Smith in view of Patent Application Publication No. 2002/0056894 to Kuo et al.

Regarding claim 35, Smith teaches a semiconductor package comprising: a die (120);

a wire bonding package substrate (390) positioned under the die, the package substrate having a die attach pad (308) and a plurality of lead fingers (109) surrounding the die attach pad;

a plurality of wire bonds (351, 371) electrically connecting the die to the plurality of lead fingers;

a bottom plate (107) under the die attach pad; and

an insulator (380) set between the die attach pad and the bottom plate such that the die attach pad and the bottom plate are electrically insulated from each other by the insulator.

Smith does not teach a package, wherein the die attach pad has an expansion slot. Kuo et al. teach a package (Fig. 2, for example), wherein the die attach pad has slots (511 – 517) which would have performed the function of "expansion slots". It would have been obvious to one of ordinary skill in the art at the time the invention was made to incorporate the slots taught by Kuo et al. into the package taught by Smith, since it is desirable to restrict the movement of solder when attaching the die (paragraph [0007]; Also see Smith, Col. 3, lines 16 - 22).

Regarding claim 36, Smith teaches a method of assembling a semiconductor package, comprising:

providing a wire bonding package substrate (390) with a die attach pad (308) and a plurality of lead fingers (109) surrounding the die attach pad, the die attach pad having a top surface and a bottom surface;

attaching a die (120) to the top surface of the die attach pad;

setting in place an insulator (380) to the bottom plate;

attaching the bottom plate to the bottom surface of the die attach pad such that the bottom plate and the die attach pad are electrically insulated from each other by the insulator; and

electrically connecting a plurality of wire bonds from the die to the plurality of lead fingers.

Art Unit: 2811

Smith does not teach a package, wherein the die attach pad has an expansion slot. Kuo et al. teach a package (Fig. 2, for example), wherein the die attach pad has slots (511 – 517) which would have performed the function of "expansion slots". It would have been obvious to one of ordinary skill in the art at the time the invention was made to incorporate the slots taught by Kuo et al. into the package taught by Smith, since it is desirable to restrict the movement of solder when attaching the die (paragraph [0007]; Also see Smith, Col. 3, lines 16 - 22).

Allowable Subject Matter

4. Claims 1 – 34 are allowed.

Conclusion

5. Applicant's amendment necessitated the new ground(s) of rejection presented in this Office action. Accordingly, **THIS ACTION IS MADE FINAL**. See MPEP § 706.07(a). Applicant is reminded of the extension of time policy as set forth in 37 CFR 1.136(a).

A shortened statutory period for reply to this final action is set to expire THREE MONTHS from the mailing date of this action. In the event a first reply is filed within TWO MONTHS of the mailing date of this final action and the advisory action is not mailed until after the end of the THREE-MONTH shortened statutory period, then the shortened statutory period will expire on the date the advisory action is mailed, and any extension fee pursuant to 37 CFR 1.136(a) will be calculated from the mailing date of the advisory action. In no event, however, will the statutory period for reply expire later than SIX MONTHS from the date of this final action.

Any inquiry concerning this communication or earlier communications from the examiner should be directed to Douglas W. Owens whose telephone number is 571-272-1662. The examiner can normally be reached on Monday-Friday.

If attempts to reach the examiner by telephone are unsuccessful, the examiner's supervisor, Eddie C. Lee can be reached on 571-272-1732. The fax phone number for the organization where this application or proceeding is assigned is 571-273-8300.

Information regarding the status of an application may be obtained from the Patent Application Information Retrieval (PAIR) system. Status information for published applications may be obtained from either Private PAIR or Public PAIR. Status information for unpublished applications is available through Private PAIR only. For more information about the PAIR system, see http://pair-direct.uspto.gov. Should you have questions on access to the Private PAIR system, contact the Electronic Business Center (EBC) at 866-217-9197 (toll-free). If you would like assistance from a USPTO Customer Service Representative or access to the automated information system, call 800-786-9199 (IN USA OR CANADA) or 571-272-1000.

Douglas W Owens Primary Examiner Art Unit 2811

Dougla K. Owan

DWO September 13, 2006